ASSOCIATION O	CONNECTING NOUSTRIES*	<b>sition Dec</b> C, Bannockb American co	claration ourn, Illinois. A opyright conve	All rights reserved untions.	under both	This docume level parts, t	ent is a declarat	tion of the ncompa	ne substances asses all lowe	within the r level ma	e manufactur terials for wi	er listed it hich the m	em. Note: i anufacturer	f the item is an as r has engineering	sembly with low responsibility.	
752-21.1					Form Type Distribute	Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homogeneous Mat					eous Materi	rials and Mfg Information				
upplier ]	Information															
Company name* Com				Company unique ID			Unique ID Authority					Response Date*				
nsemi												2024-05-22				
ontact Nai	me		Title - Contact				Phone - Contact*					Email - Contact*				
Product-En	nv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized	Representative*		Title - Representative				Phone - Representative*				Email - Representative*					
roduct-En	ıv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
]	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	tive Date Version Manufactur		ring Site	Site Weight*		UOM	Unit Type		
	NOIP1SN0480A-ST		N0480A-STI	PYTHON480 1/3.6", BW_CRA1.65			2024-05-22		,	TWU		3	8.3603	mg	Each	
lanufact	turing Proccess Informati	on		, 			·	1						l		
Т	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020		J-STD-020 MSI	L Rating	Peak Process Body Tempera		ly Temperatu	ture Max Time at Peak Temp		Temperatu	ire Numb	per of Reflow Cyc	cles	
SnAgCu		C	CU Alloy 4			245 C		C	30		second	ls 3				
omments																
or more in	formation regarding material co	omposition	please refer to	o page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl halate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	6.6894	mg	Supplier	Silicon (Si)	7440-21-3		6.6894	mg
Glass Attach Epoxy	0.0053	mg		Miscellaneous	trade secret		0.0007	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0046	mg
Glass Lid /Cap	29.3747	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		2.9375	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		1.4687	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		1.4687	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.9375	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		1.4687	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		19.0936	mg
Metal Shielding	0.0483	mg	Supplier	Copper (Cu)	7440-50-8		0.0002	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0481	mg
RDL	0.053	mg	В	Nickel (Ni)	7440-02-0		0.0328	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0001	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0198	mg
older Ball	2.1563	mg	Supplier	Silver (Ag)	7440-22-4		0.0647	mg
			Supplier	Tin (Sn)	7440-31-5		2.0808	mg
			Supplier	Copper (Cu)	7440-50-8		0.0108	mg
Substrate and Solder Mask	0.0333	mg	Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0033	mg
			Supplier	9-Phenylacridine	602-56-2		0.0017	mg
			Supplier	2-Propenoic acid	1245638-61-2		0.0033	mg
			Supplier	3-Methoxy-1-butanol	2517-43-3		0.0083	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.0083	mg
			Supplier	1-Methoxy-2-propyl acetate (MPA)	108-65-6		0.0083	mg